



## Ultrafast Avalanche SMD Rectifier



DO-214AC (SMA)

### FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Low reverse current
- Low forward voltage
- Soft recovery characteristic
- Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
$V_{RRM}$	50 V, 100 V, 200 V
$I_{FSM}$	35 A
$I_R$	1.0 $\mu$ A
$V_F$	1.1 V
$t_{rr}$	25 ns
$E_R$	20 mJ
$T_J$ max.	150 °C
Package	DO-214AC (SMA)
Diode variations	Single die

### TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

### MECHANICAL DATA

**Case:** DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** Color band denotes the cathode end

MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	BYG22A	BYG22B	BYG22D	UNIT
Device marking code		BYG22A	BYG22B	BYG22D	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	V
Average forward current	$I_{F(AV)}$	2.0			A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	35			A
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1\text{ A}, T_J = 25\text{ °C}$	$E_R$	20			mJ
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150			°C



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYG22A	BYG22B	BYG22D	UNIT
Maximum instantaneous forward voltage	$I_F = 1.0\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	1.0			V
	$I_F = 2.0\text{ A}$			1.1			
Maximum reverse current	$V_R = V_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$	$I_R$	1			$\mu\text{A}$
		$T_J = 100\text{ }^\circ\text{C}$		10			
Maximum reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		$t_{rr}$	25			ns

**Note**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	BYG22A	BYG22B	BYG22D	UNIT	
Maximum thermal resistance, junction to lead, $T_L = \text{const.}$	$R_{\theta JL}$	25			$^\circ\text{C/W}$	
Maximum thermal resistance, junction to ambient	$R_{\theta JA}^{(1)}$	150			$^\circ\text{C/W}$	
	$R_{\theta JA}^{(2)}$	125				
	$R_{\theta JA}^{(3)}$	100				

**Notes**

- (1) Mounted on epoxy-glass hard tissue  
 (2) Mounted on epoxy-glass hard tissue, 50 mm<sup>2</sup> 35  $\mu\text{m}$  Cu  
 (3) Mounted on Al-oxide-ceramic (Al<sub>2</sub>O<sub>3</sub>), 50 mm<sup>2</sup> 35  $\mu\text{m}$  Cu

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
BYG22A-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG22A-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG22AHM3/TR <sup>(1)</sup>	0.064	TR	1800	7" diameter plastic tape and reel
BYG22AHM3/TR3 <sup>(1)</sup>	0.064	TR3	7500	13" diameter plastic tape and reel

**Note**

(1) AEC-Q101 qualified



## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

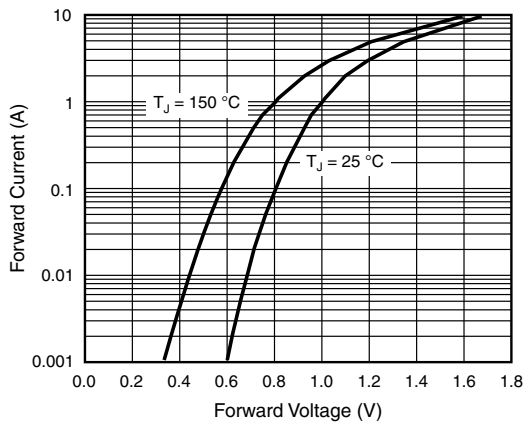


Fig. 1 - Forward Current vs. Forward Voltage

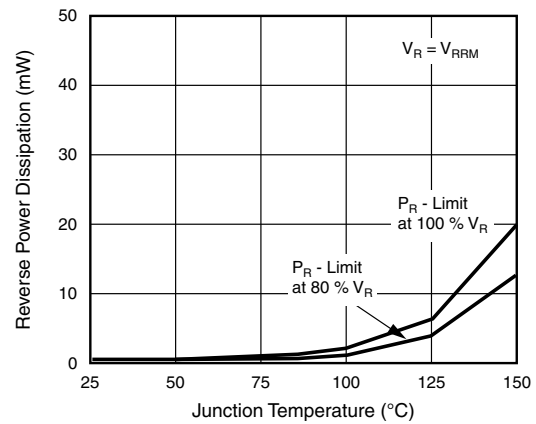


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

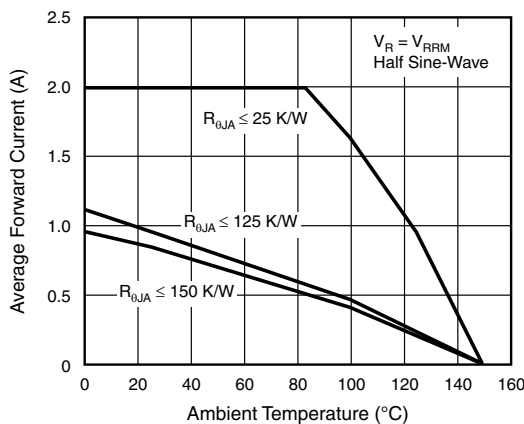


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

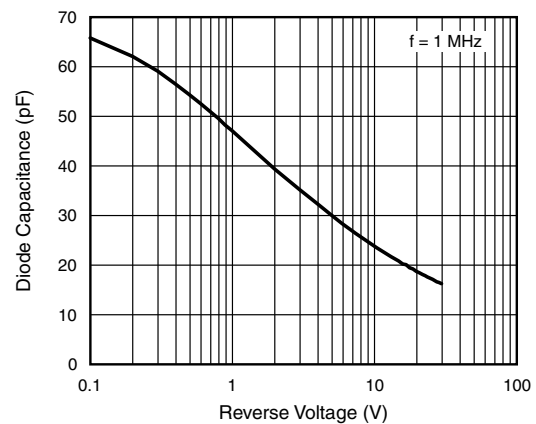


Fig. 5 - Diode Capacitance vs. Reverse Voltage

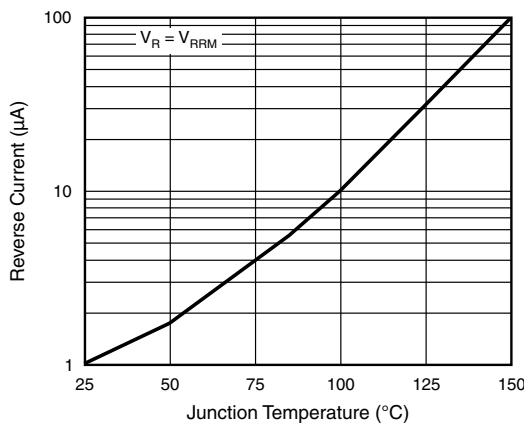


Fig. 3 - Reverse Current vs. Junction Temperature

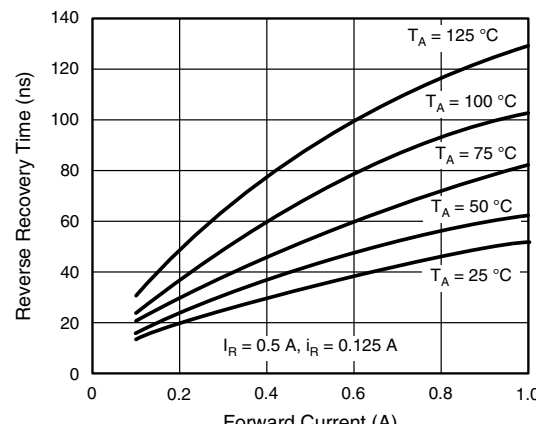


Fig. 6 - Max. Reverse Recovery Time vs. Forward Current

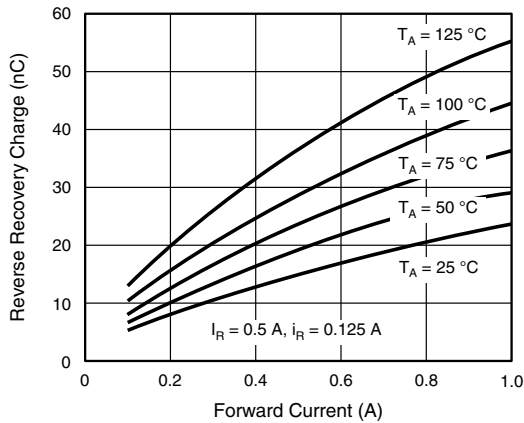


Fig. 7 - Max. Reverse Recovery Charge vs. Forward Current

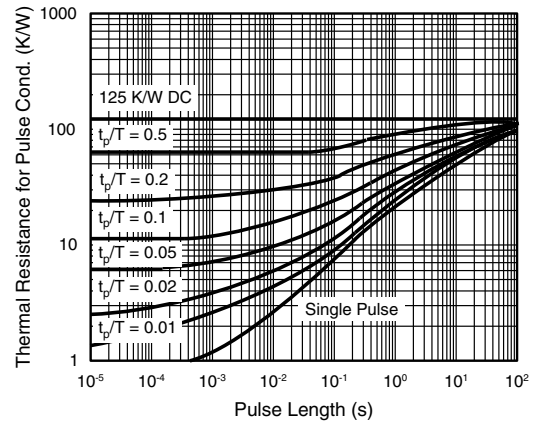
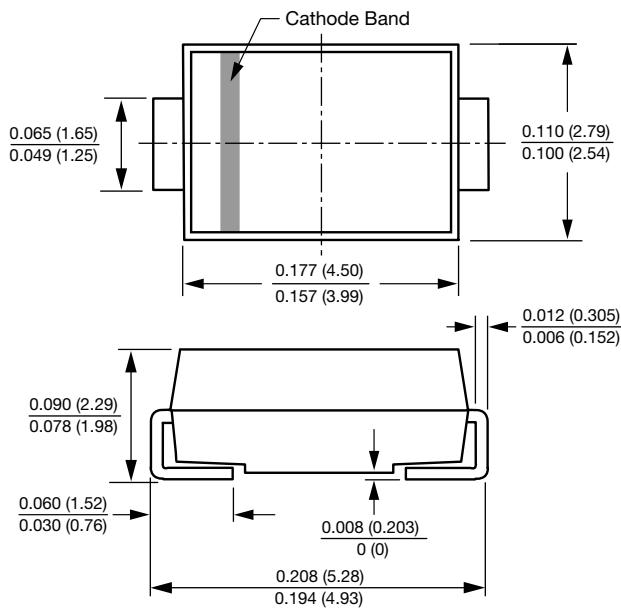


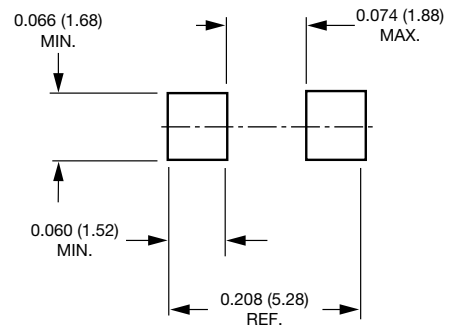
Fig. 8 - Thermal Response

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**DO-214AC (SMA)**



**Mounting Pad Layout**





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